

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
PATENT APPLICATION

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Appl. No. : 10/762,122  
Applicant : Donald C. Abbott et al.  
Filed : January 20, 2004  
TC/A.U. : 2812  
Examiner : Roman, Angel

Confirmation No. 3955

Docket No. : TI-33737A  
Customer No. : 23494

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Jackie McBride  
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**Amendment-A under 37 C.F.R. 1.111**

Dear Sir:

Responsive to the Office action dated December 13, 2004, applicants amend the application as follows:

**Listing of claims** begins on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of  
**Abbott et al.**

Docket Number: TI-33737A

Serial No.: 10/762,122

Art Unit: 2812

Filed: January 20, 2004

Examiner: Roman, Angel

For: SEMICONDUCTOR LEADFRAMES PLATED WITH THICK NICKEL,  
MINIMUM PALLADIUM, AND PURE TIN

## CERTIFICATION OF FACSIMILE TRANSMISSION

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## FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT (5 pages)
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT (# Page)
<input type="checkbox"/> DECLARATION (# Pages)	<input type="checkbox"/> NOTICE OF APPEAL (1 Page)
<input type="checkbox"/> ASSIGNMENT (# Pages)	<input type="checkbox"/> APPEAL (# Pages)
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<input type="checkbox"/> CONTINUATION APP'N (# Pages)	<input checked="" type="checkbox"/> IDS & FORM PTO 1449 (2 pgs)
NAME OF INVENTOR(S): <b>Abbott et al.</b>	
RECEIPT DATE & SERIAL NO.: Serial No.: <b>10/762,122</b>	
TITLE OF INVENTION: <b>Semiconductor Leadframes Plated with..</b>	
Filing Date: <b>01/20/2004</b>	
TI FILE NO.: <b>TI-33737A</b>	DEPOSIT ACCT. NO.: <b>20-0668</b>
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